# Protecting Low Voltage ADC from High Voltage Amp

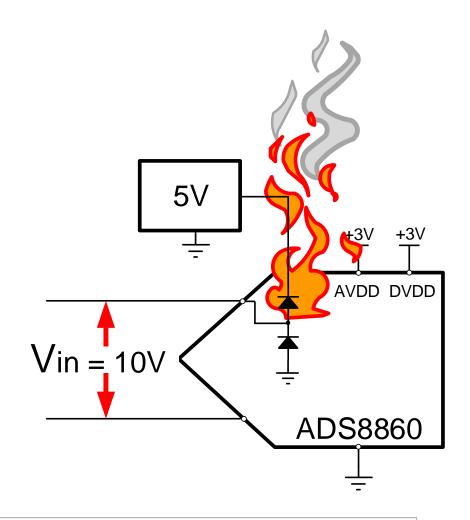
TI Precision Labs - ADCs

Presented by Alex Smith Prepared by Dale Li



### **Absolute Maximum Ratings – Data Converters**

- Absolute Maximum (Abs Max) Ratings represent the voltage/current ratings. Exceeding these ratings may damage the device
- Exceeding Abs Max ratings can also degrade device reliability and cause permanent degradation in performance
- Abs Max Ratings are at or beyond linear operating conditions
- Input protection schemes should ensure that the device is not exposed to conditions that exceed the Abs Max Ratings



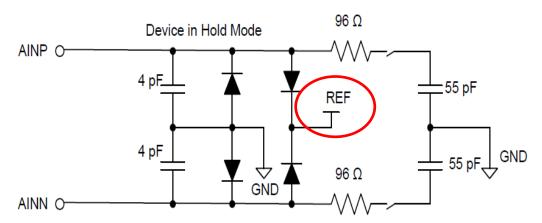
# **Abs Max Ratings - Input Voltage**

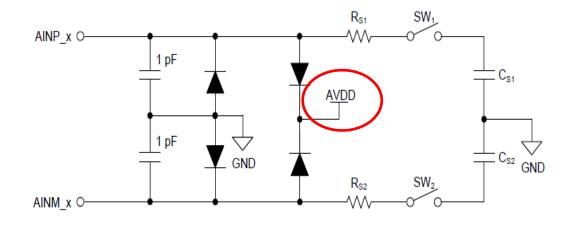
### **ADS8860:**

Absolute Maximum Ratings	MIN	MAX	UNIT
AINP to GND or AINN to GND	-0.3	REF+0.3	V
AVDD to GND or DVDD to GND	-0.3	4	V
REF to GND	-0.3	5.7	V
Digital Input Voltage to GND	-0.3	DVDD+0.3	V
Digital Output to GND	-0.3	DVDD+0.3	V

### ADS9224R:

Absolute Maximum Ratings	MIN	MAX	UNIT
AINP to GND or AINM to GND	-0.3	AVDD+0.3	V
AVDD to GND	-0.3	6	V
DVDD to GND	-0.3	6	V
Digital Input Voltage	-0.3	DVDD+0.3	V
Input or Output Current	-10	+10	mA





(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under electrical characteristics is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# **Abs Max Ratings - Current Limit**

### **ADS8588S:**

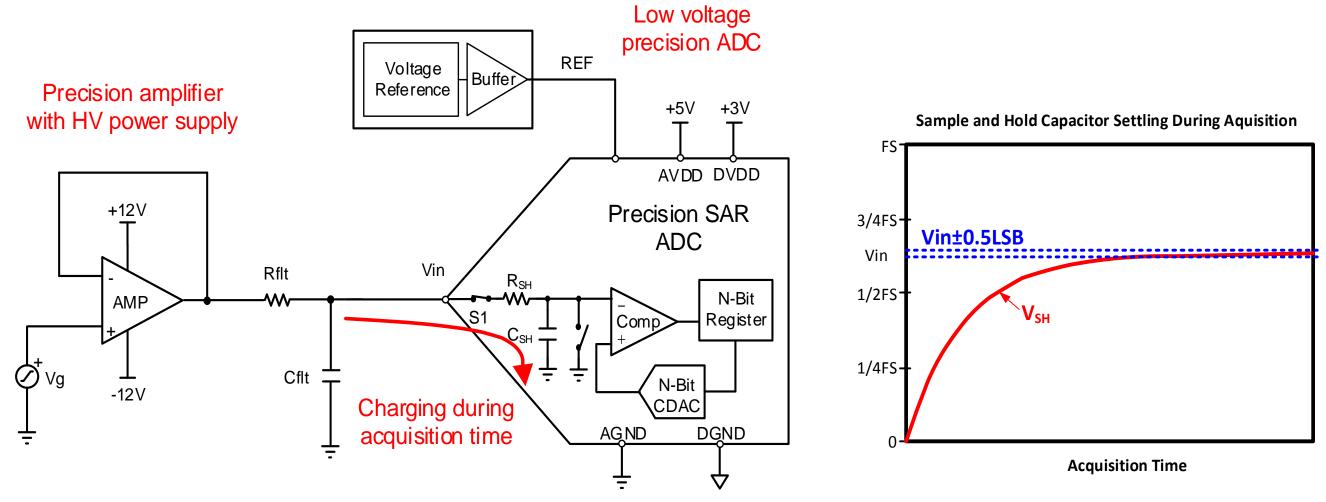
Absolute Maximum Ratings	MIN	MAX	UNIT
Analog Input Voltage to AGND	-15	+15	V
AVDD(DVDD) to AGND(DGND)	-0.3	7	V
REFIN to AGND	-0.3	AVDD+0.3	V
Digital Input to DGND	-0.3	DVDD+0.3	V
Input or Output Current	-10	+10	mA

### **ADS9224R:**

Absolute Maximum Ratings	MIN	MAX	UNIT
AINP to GND or AINM to GND	-0.3	AVDD+0.3	V
AVDD to GND	-0.3	6	V
DVDD to GND	-0.3	6	V
Digital Input Voltage	-0.3	DVDD+0.3	V
Input or Output Current	-10	+10	mA

- Limiting input current to be less than 10mA with a margin is recommended
- Resistance(R) in series with the inputs can limit the input current and protect the ADC
- Larger value R can make device safer and reduce the chance of a Latch-up event, and help to clamp overvoltage input signal with external protection diodes
- Larger value R may affect signal settling on CsH for Switched-capacitor Input ADCs

### Common Data Acquisition System in industrial application

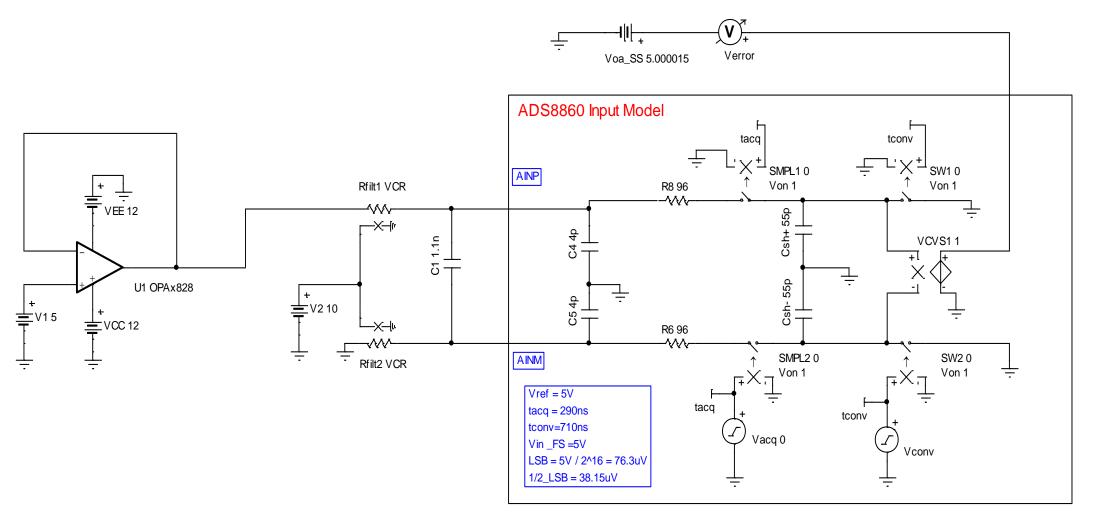


### **Driving Circuit:**

- Proper Rfilt and Cfilt in charge bucket filter will optimize signal settling.
- Achieve final settling of 0.5LSB or better at end of tacq (acquisition time).

# Driving Circuit without External diode - Simulation

Based on Precision labs training, build SAR Model and find proper RC with amp to drive:



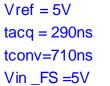


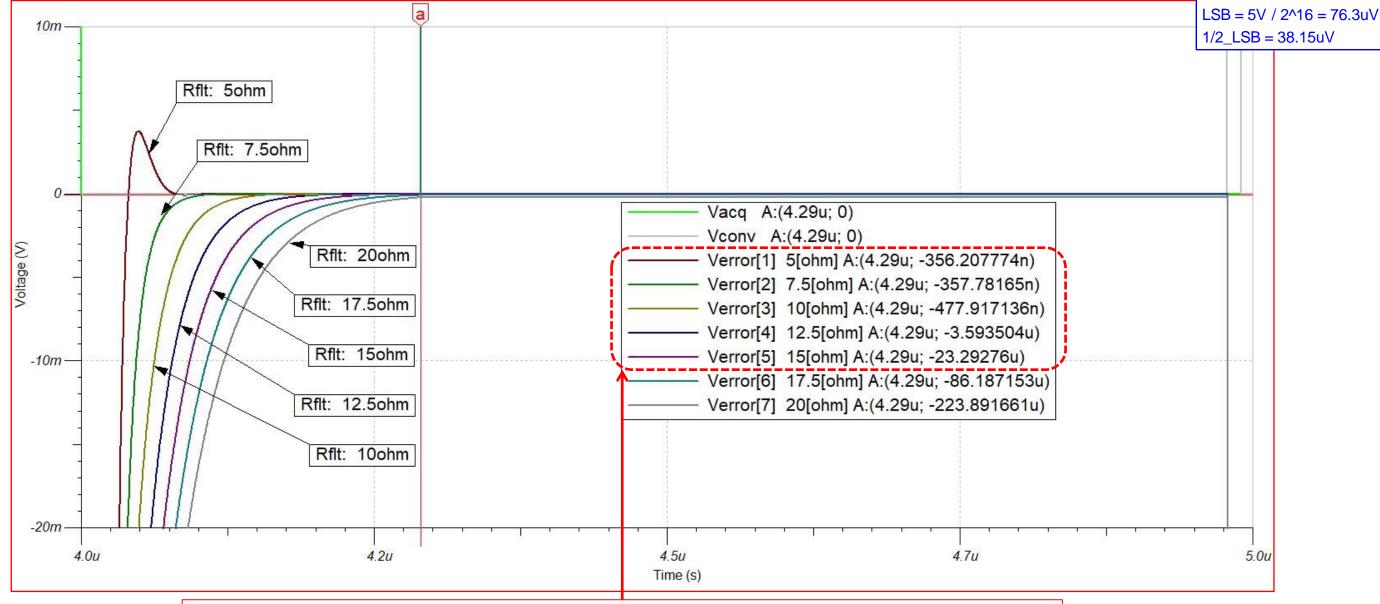
- High Bandwidth OPA828 is selected to drive ADS8860.
- Rflt ≤ **15.8**Ω to achieve settling error less than 0.5LSB.





# Settling Error Check (Rflt=15ohm, Cflt=1.1nF)





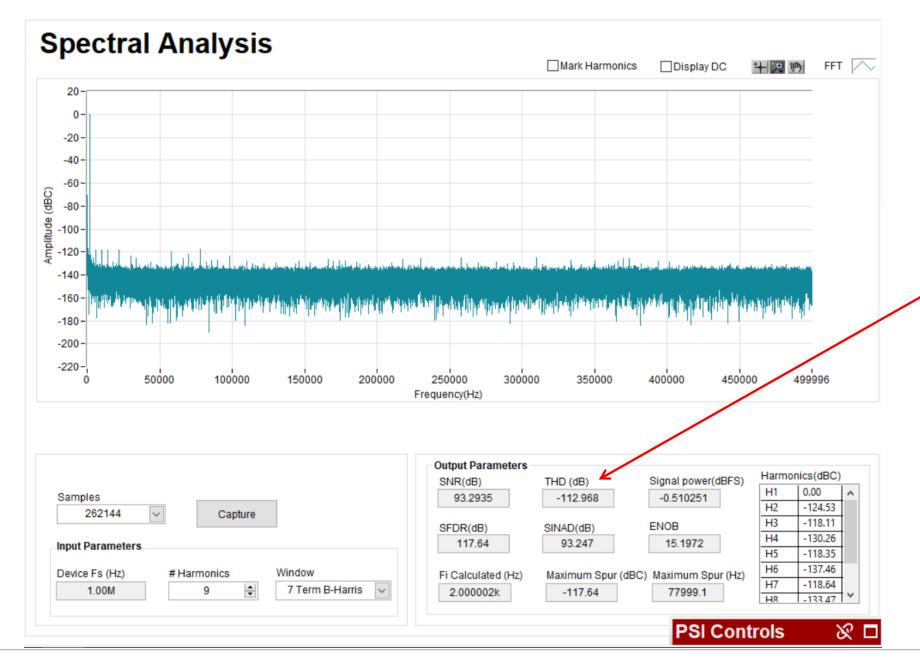
At end of Vacq, Verror = -23.3uV -> 0.305 LSB (Rflt=15 $\Omega$ )!!

Note: <1/2 LSB is expected.



### **Hardware Performance Check**

(Rflt=15Ω, Cflt=1.1nF, OPA828+ADS8860 at 1Msps sampling rate)



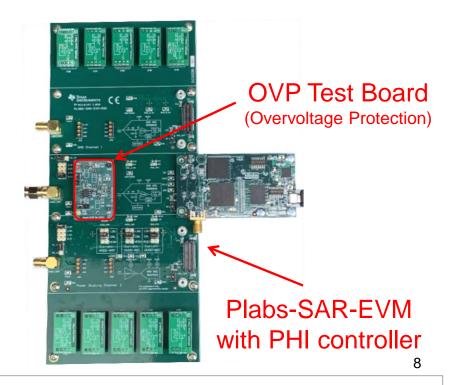
### ADS8860 Data Sheet (1Msps)

Parameter	Min	Тур	Max	Unit
SNR	92	93		dB
THD		-108		dB

### **Measured:**

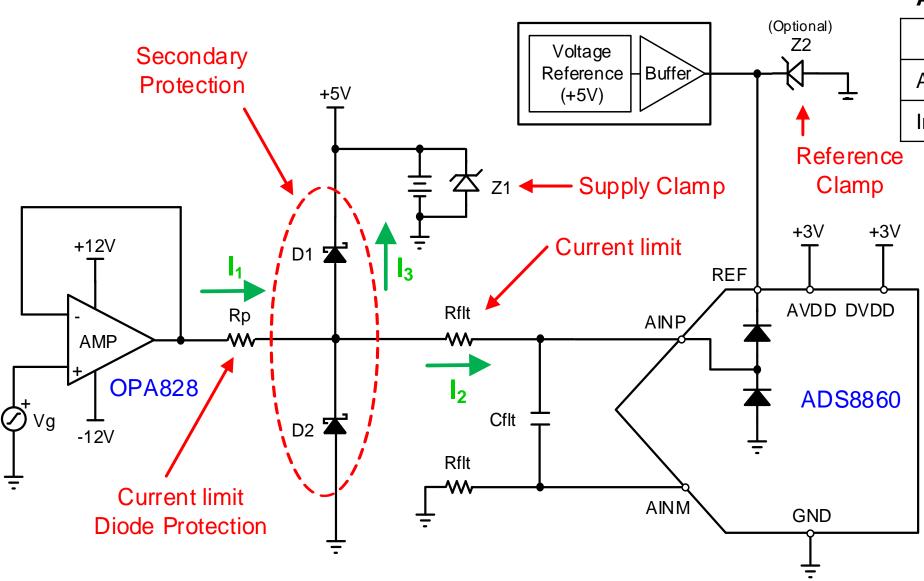
SNR = 93.29dB

THD = -112.9dB





# Input Protection—External Diode



### **ADS8860 Absolute Maximum Ratings:**

	Min	Max	Unit
AINP to GND or AINN to GND	-0.3	REF+0.3	V
Input Current	-10	10	mA

### Note:

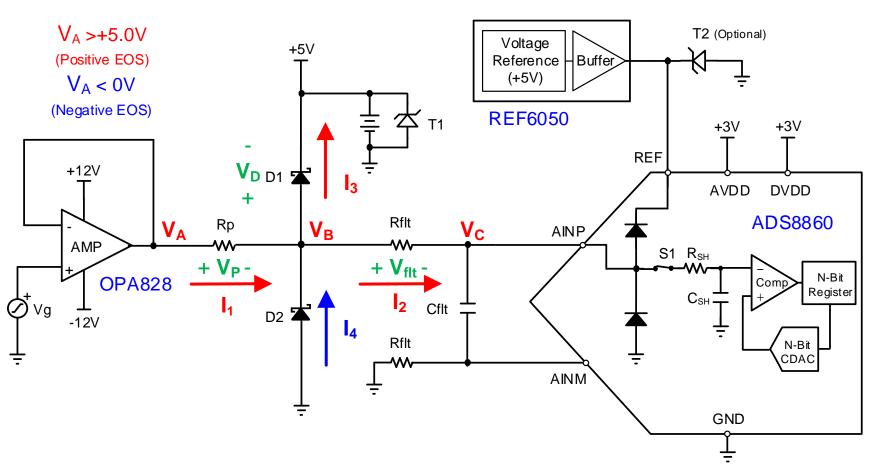
 $R_{flt}$  forces  $I_2 \ll I_3$ ,

which ensures that the majority of the surge Energy is diverted by external Diodes rather than by the IC's internal protection diodes.

Understanding the protection scheme

OPA828 Max Output Voltage:					
EOS Voltage range (Vo) $-12V \le V_0 < 0V$ $5V < V_0 \le 12V$					
OPA828 Max Output Current:					
Short-circuit current (I <sub>SC</sub> ) ±50mA					

ADS8860 Absolute Maximum Ratings:						
Min Max Unit						
AINP or AINN to GND	-0.3	+5.3	V			
Input Current -10 +10 mA						



### Normal Operation:

▶ D₁ and D₁ are Reverse-Biased.

### Positive EOS: V<sub>△</sub> > 5V

- ➤ Forward-Biased on D₁ for positive EOS.
- ➤ Reverse-Biased state on D₂.

### Negative EOS: V<sub>A</sub>< 0V</li>

- $\triangleright$  Forward-Biased on D<sub>2</sub> for negative EOS.
- ➤ Reverse-Biased state on D<sub>1</sub>.

### • R<sub>P</sub> considerations

- ➤ Limiting total current I₁.
- ➤ Lower I<sub>1</sub> keeps V<sub>D</sub> lower
- ➤ Watch the power in R<sub>P</sub> and the Amp

### • V<sub>D</sub> is smaller to keep:

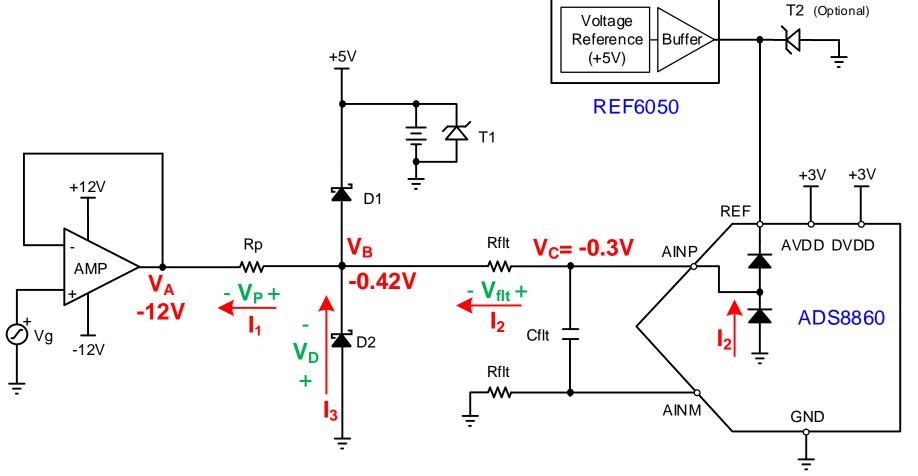
- ➤ Lower V<sub>B</sub>.
- ➤ Lower  $V_C$  (Better  $\leq +5.3V$ ).
- I<sub>2</sub> should be less than 10mA.

### Impact to settle signal on ADC's C<sub>SH</sub>:

- ➤ Larger R<sub>P</sub> and Rfil degrade settling
- > Diode's capacitance.
- Diode's leakage current.



# Select R<sub>P</sub> and R<sub>flt</sub>



Par	Parameters known:						
1	I <sub>1</sub> (OPA828)	±50mA (Short current, I <sub>SC</sub> )					
2	<b>V<sub>A</sub></b> (OPA828)	$\pm 12V$ (Maximum, $V_0$ )					
3	I <sub>2</sub> (ADC Input)	±10mA (Maximum, I <sub>ADC_in_Abs</sub> )					
4	V <sub>C</sub> (ADC Input)	+5.3V (Maximum, V <sub>ADC_in_max</sub> ) -0.3V (Minimum, V <sub>ADC_in_min</sub> )					
Sel	Select R <sub>P</sub> and R <sub>flt</sub> (for negative EOS):						
1	1	$I_{3(min)} = I_1 - I_2 = 40mA$					
•	l <sub>3</sub>	$I_{3(max)} = I_1 - 0 = 50mA$					
2	V <sub>D</sub> (BAT54)	$V_D = 0.42V$ (Selected V <sub>F</sub> )					
3	V <sub>B</sub>	$V_B = -0.42V$					
4	R <sub>P</sub>	$R_P > \frac{(12 - 0.42)V}{50mA} > 232\Omega$					
5	R <sub>flt</sub>	$R_{flt} \ge \frac{(0.42 - 0.3)V}{10mA} \ge 12\Omega$					
6	Select $R_{flt} = 15\Omega$ , $R_P = 249\Omega$						

# **Diode Comparison Chart - Schottky**

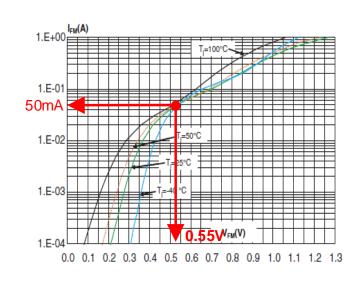
### **Electrical Characteristics:**

Part Numbers	Manufacturer	Reverse Breakdown Voltage(V <sub>BR</sub>		Forward voltage (∨ <sub>F</sub> ) mV	Leakage current (I <sub>R</sub> ) uA	Total Capacitance (C <sub>T</sub> ) pF	Forward continuous current (I <sub>F</sub> )mA	Repetitive peak forward current (I <sub>FSM</sub> ) A	Power Dissipation (P <sub>D</sub> ) mW
1N5712	Avago	20		580@10mA	0.15	1.2	35		250
BAT54	Diodes	30	<u>†</u>	400mV@10mA	2.0	10	200	0.3	200
ВАТ60	Infineon	10	$\int$	150mV@10mA	1000	35	3000	5	1350
BAS70	Infineon	70		750mV@10mA	0.1	2	70	0.1	250
1PS70SB82	NXP	15		340mV@1mA	0.2	1@typ	30		
DB2S20500L	Panasonic	20		390mV@200mA	50	30	200	1	
VS-10BQ015- M3/5BT	Vishay	15		330 @1A	500	390	1000	140	

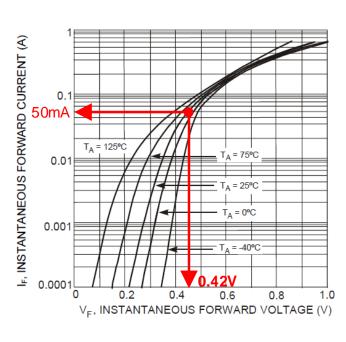
BAT54 has the best trade off for forward voltage, leakage, and capacitance.

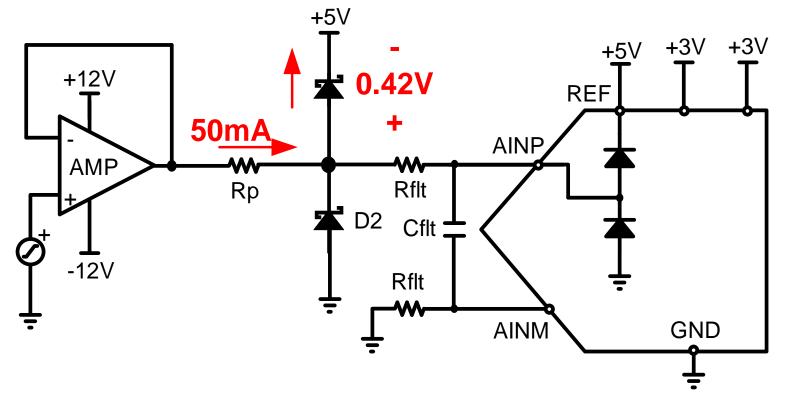
# **Using Diode V-I Curves**

### **ST – BAT54**



### Diodes Inc. - BAT54



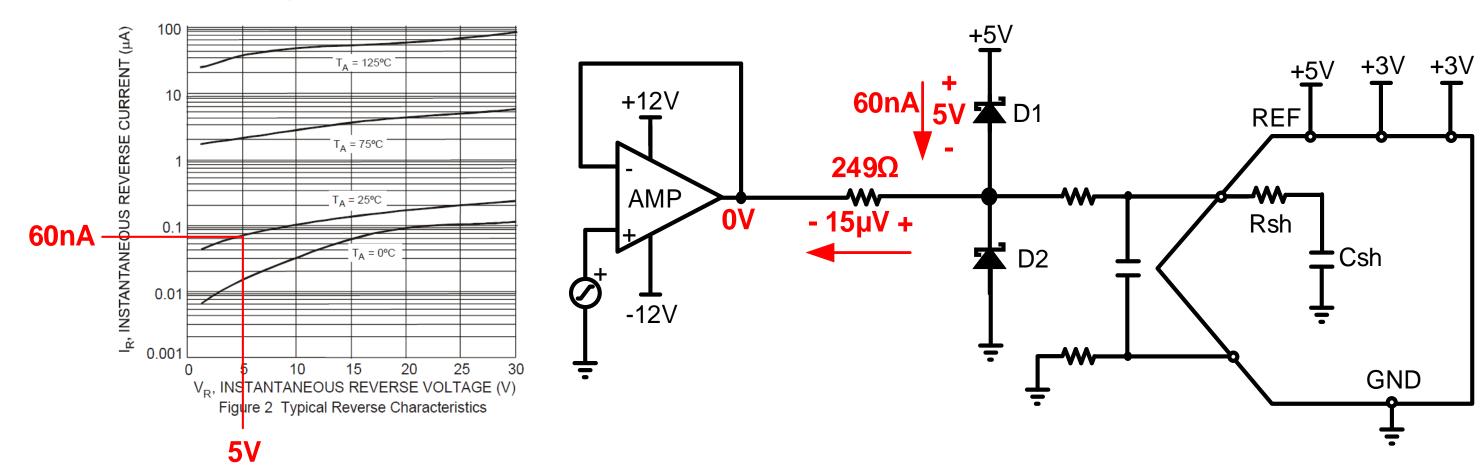


- BAT54 from "Diodes Inc." manufacturer has better forward voltage (V = 0.42V)
- Same current (I<sub>F</sub> = 50mA)
- Same temperature (+25°C).

### Reverse leakage current on Diode – Not issue for this example

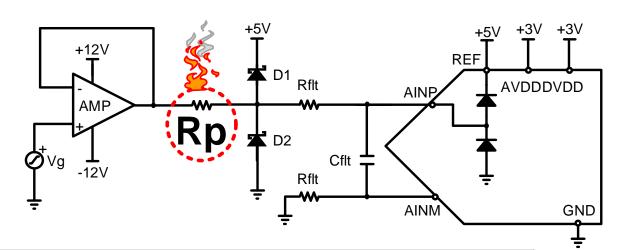
- Leakage current is not constant with reserve voltage(<1uA for BAT54 at room temp).</li>
- Leakage current is changing with temperature.

### Schottky Diode – BAT54



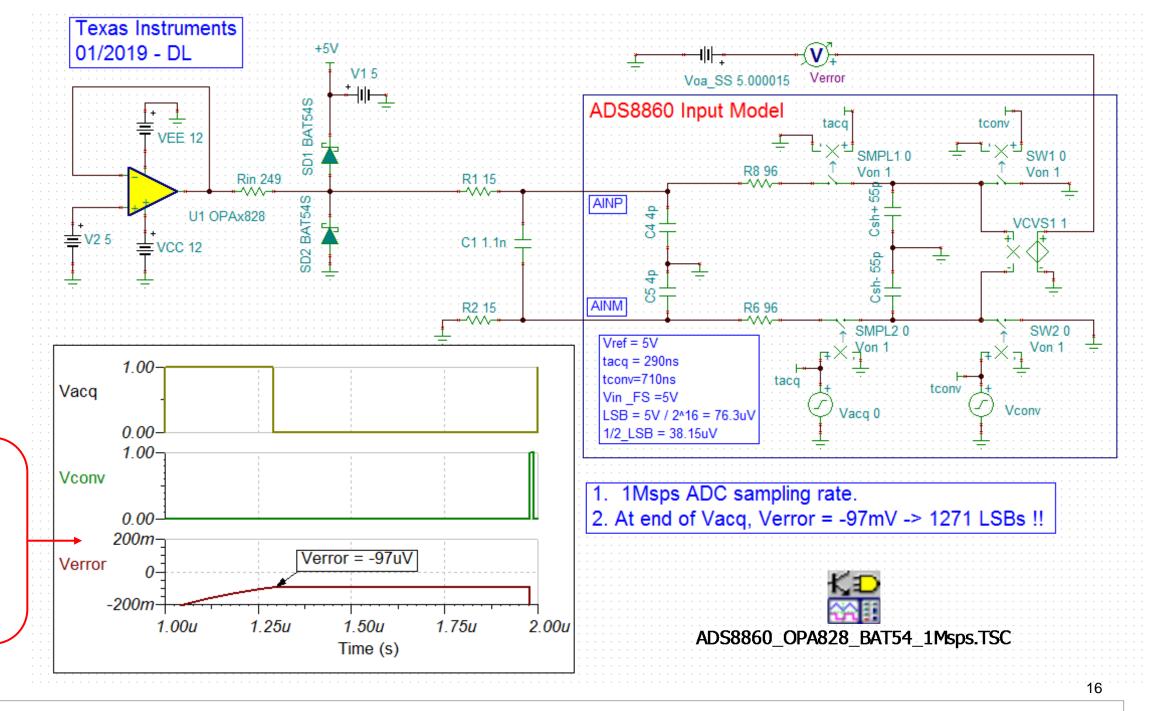
# **Power Dissipation on R<sub>P</sub>**

- Voltage drop across Rp may not be acceptable.
- Power Dissipation on Rp may be a challenge:



1	V <sub>o</sub> (OPA828)	±12V (Choose -12V for worst case across Rp)				
2	<b>V</b> <sub>B</sub>	$V_B = -0.42V$				
3	V <sub>P</sub> (Volts on R <sub>P</sub> )	$V_P = V_O - V_B = -12V - (-0.42V) = -11.58V$				
4	I <sub>1</sub> (Current through R <sub>P</sub> )	$I_1 = \frac{V_P}{R_P} = \frac{-11.58V}{249\Omega} = -38.6mA$				
5	P <sub>p</sub> (Power Dissipation on Rp)	$P_P = I_1^2 * R_P = (38.6mA)^2 * 249\Omega = 371mW$				
Note:	1. Actual resistor should have at least double power dissipation ability which requires larger package size.  2. Higher $V_0$ or power supply to amplifier will require higher power dissipation on Rp.					

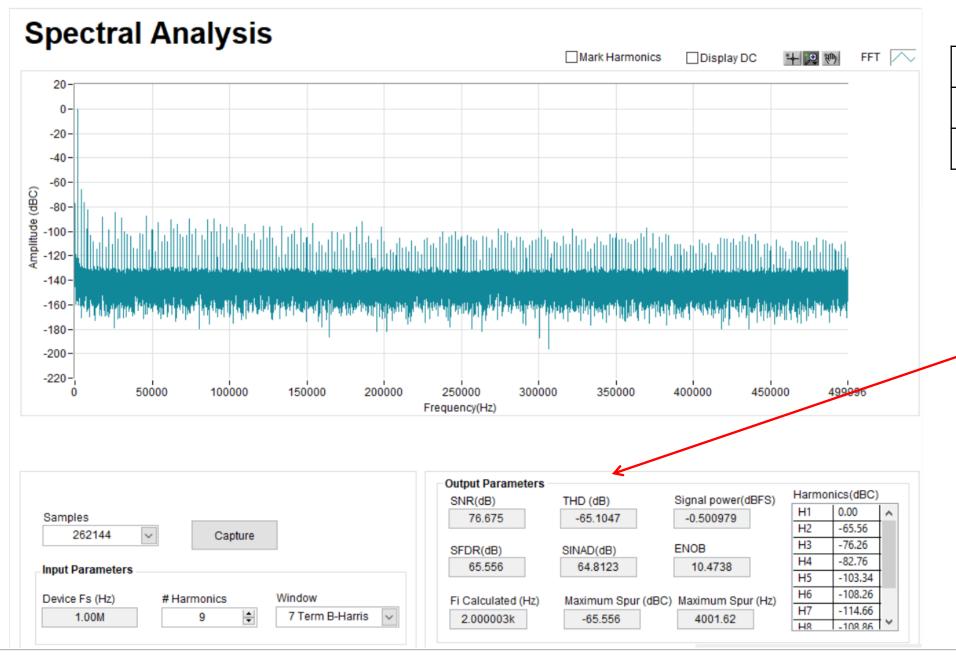
# Driving circuit with Schottky diode - Simulation



The settling error target is less than 38µV, so 97mV is a large error and poor THD and SNR is expected.

### **Hardware Performance Check**

(BAT54 Schottky diode, Rp=249 $\Omega$ , RfIt=15 $\Omega$ , CfIt=1.1nF, OPA828+ADS8860 at 1Msps sampling rate)



### ADS8860 Data Sheet (1Msps)

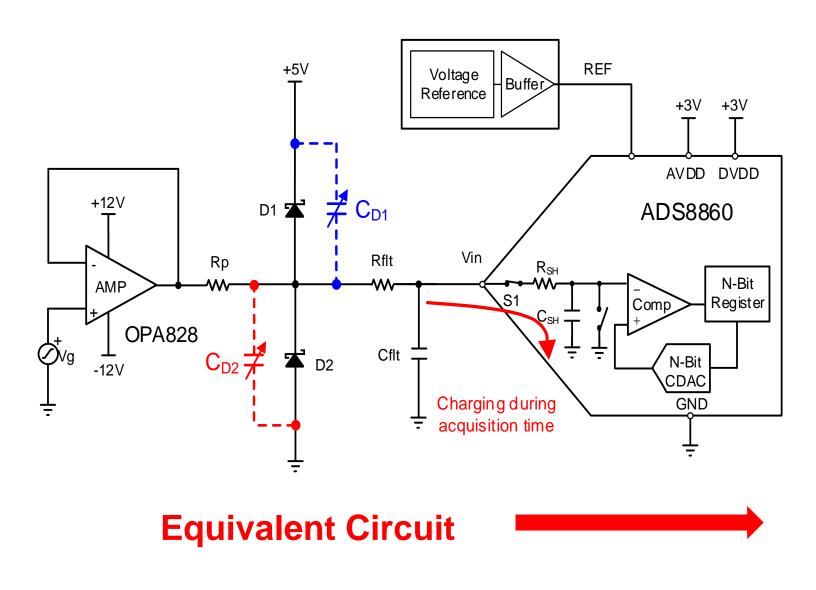
Parameter	Min	Тур	Max	Unit
SNR	92	93		dB
THD		-108		dB

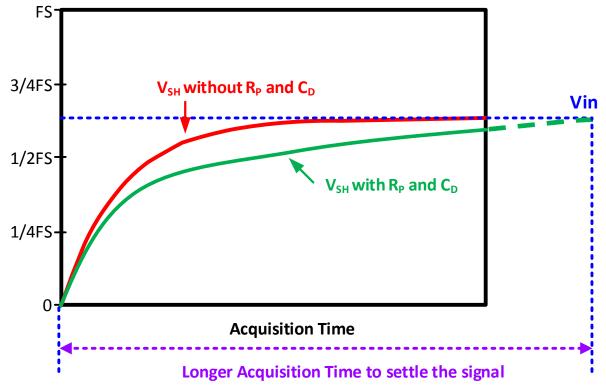
### **Measured with BAT54:**

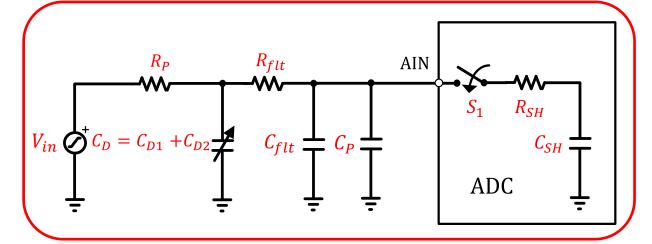
SNR = 76.6dB

THD = -65.1dB

# Large series resistance impacts settling





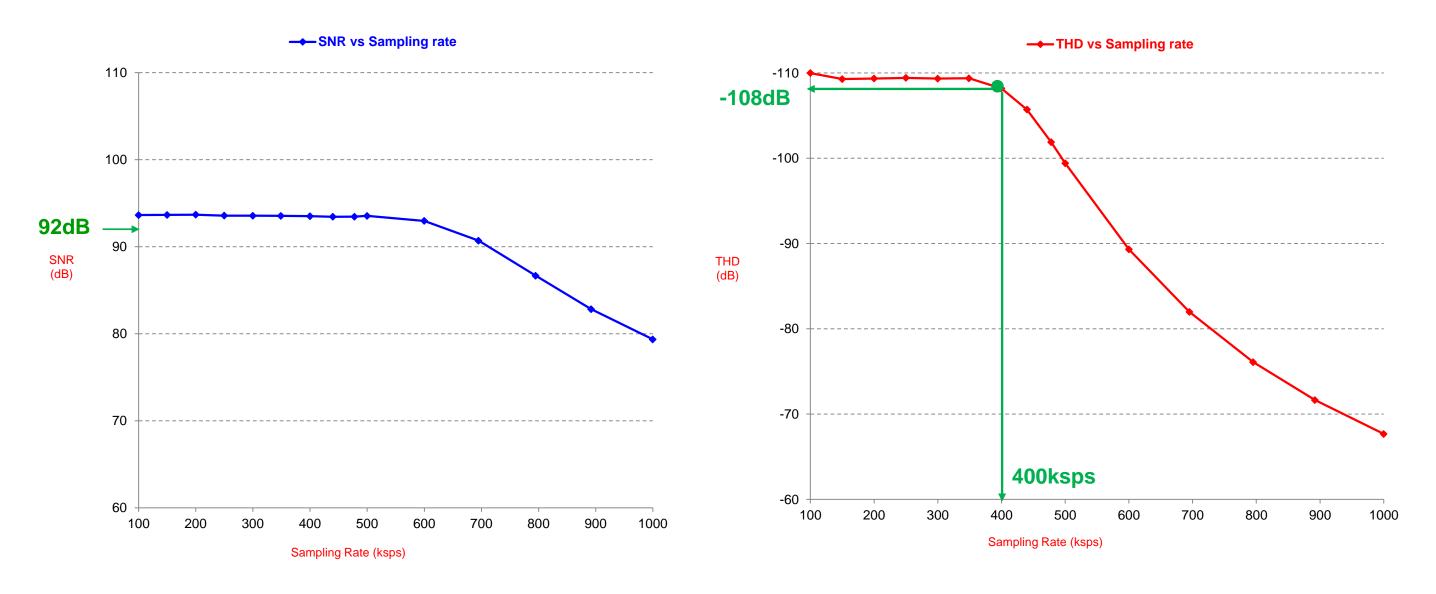


- Need longer time to settle the signal with R<sub>P</sub> and Rfilt
- Reducing F<sub>S</sub> can extend the ADC's acquisition time to meet the requirement.
- \* C<sub>P</sub> is parasitic capacitance. 18



### **Limitation on Protection Solution – Hardware Check**

Sampling rate ≤ 400ksps can achieve the performance specified in ADS8860 datasheet.

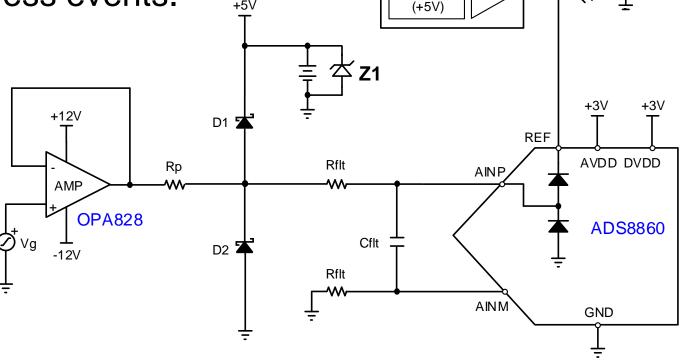


Note: Real test results with 2kHz sinewave and  $R_P = 200\Omega$ ,  $R_{flt} = 15\Omega$ ,  $R_{flt} = 1.1$ nF on OVP card and Plabs-SAR-EVM hardware.



# Thanks for your time! Please try the quiz.

- For the circuit below, what is the purpose of the TVS diode (Z1) on the 5V supply for the Schottky diodes?
  - a. The 5V supply may not be able to sink current; the TVS will turn on an limit the voltage for large positive transients.
  - b. The TVS is only required if the Schottky diodes are not used.
  - c. The TVS minimizes RF noise during overstress events.
  - d. The TVS regulates the 5V supply.

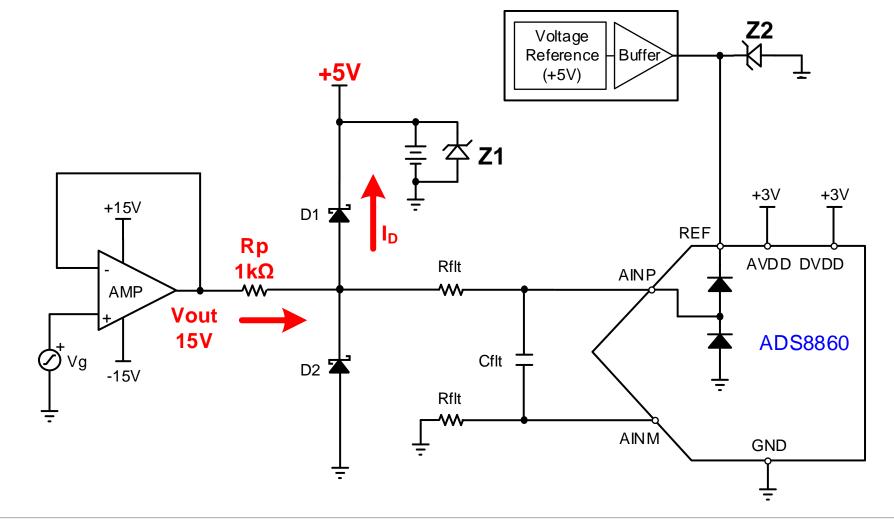


Voltage

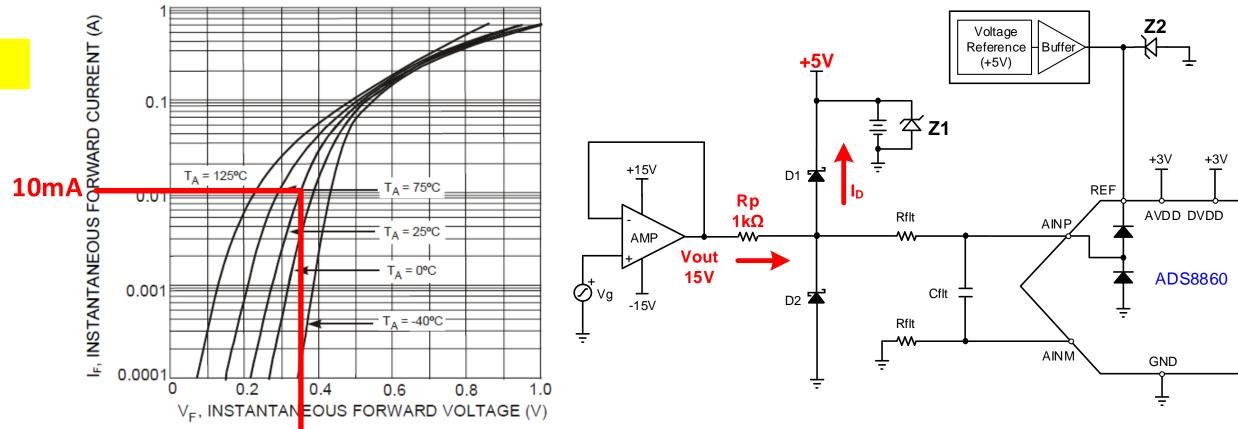
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- 2. (T/F) The internal ESD diodes can be connected to either the analog supply, or digital supply?
  - a. True.
  - b. False.
- 3. (T/F) Schottky diodes have better leakage current than a PN signal diode.
  - a. True.
  - b. False.
- 4. (T/F) Schottky diodes have lower forward voltage than a PN signal diode.
  - a. True.
  - b. False.

- 5. For the circuit below, what is the approximate current in the diode (I<sub>D</sub>)?
  - a. 1mA.
  - b. 1.5mA.
  - c. 10mA.
  - d. 15mA.
  - e. 50mA



- 6. Continuing with the circuit from the previous slide, what is the forward voltage drop across D1 at 25C?
  - a. 0.2V.
  - b. 0.25V.
  - c. 0.3V.
  - d. 0.35V.
  - e. 0.4V



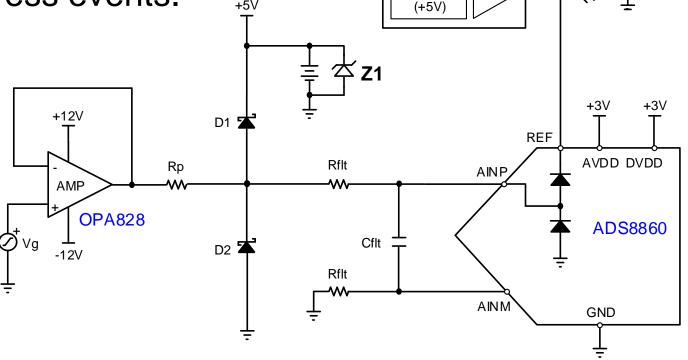
- 7. Assuming the protection circuit is causing distortion. How can the distortion be reduced?
  - a. Increase the series resistance
  - b. Increase the sampling rate.
  - c. Decrease the sampling rate
  - d. Increase the power rating of the TVS diode



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TEXAS INSTRUMENTS

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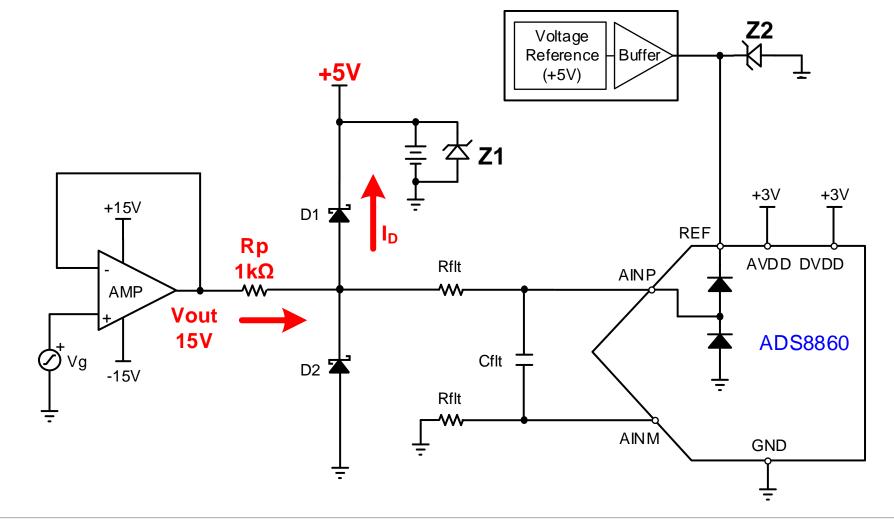


Voltage

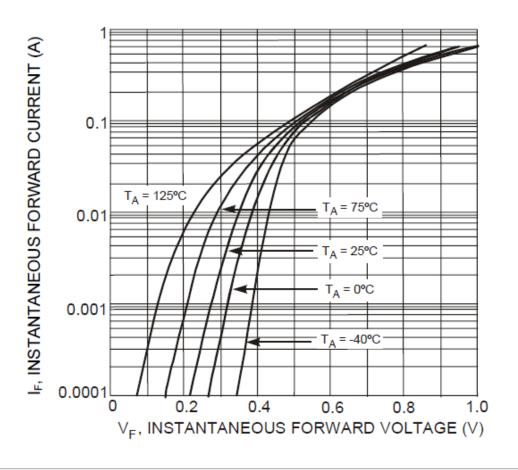
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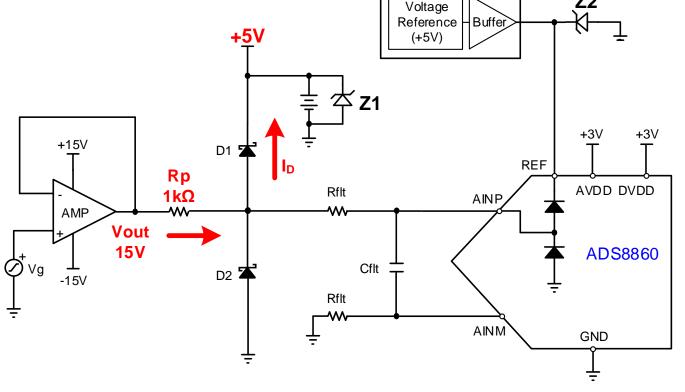
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  - e. 0.4V





# **Questions: Protecting ADC with TVS Diode - Improved**

- 7. Assuming the protection circuit is causing distortion. How can the distortion be reduced?
  - a. Increase the series resistance
  - b. Increase the sampling rate.
  - c. Decrease the sampling rate
  - d. Increase the power rating of the TVS diode